

In the Claims:

Please cancel claims 1, 2, 8 and 9, without prejudice.

Please amend claim 3 as follows:

1-2. (Cancelled)

3. (Currently Amended) An installation structure of an electronic component for a tire, ~~where an electronic component housed in~~ comprising

a case ~~is~~-installed at an arbitrary installation position in an air chamber of the tire, characterized in:the case housing the electronic component,

~~that~~ a pedestal including a base plate part which comes into contact with the installation position, and supporting parts which support the case ~~is used~~;

~~that~~ the base plate part of the pedestal ~~is being~~ attached to the installation position;

~~that~~ the case ~~is being~~ fixed to the supporting parts of the pedestal; ~~and~~

~~that~~ a heat-insulating structure ~~is~~ interposed between the case and the base plate part of the ~~pedestal~~pedestal,

a patch which can be bonded to the installation position integral with the pedestal,
through holes in the patch at positions corresponding to the supporting parts of the pedestal, the pedestal being aligned by the patch while inserting the supporting parts into the through holes, and

holes formed in at least some of the supporting parts of the pedestal for allowing binding bands to be inserted into the holes and wound around the case.

4. (Currently Amended) The installation structure of an electronic component for a tire according to any of ~~claims 1 to 3~~claim 3, wherein a heat-insulating space is interposed as the heat-insulating structure.

5. (Currently Amended) The installation structure of an electronic component for a tire according to any of ~~claims 1 to 3~~claim 3, wherein a heat-insulating material is interposed as the heat-insulating structure.

6. (Original) The installation structure of an electronic component for a tire according to claim 5, wherein the heat-insulating material is formed of any of resin foam, organic fibers and inorganic fibers.

7. (Previously Presented) The installation structure of an electronic component for a tire according to claim 3, wherein the pedestal is formed of resin of which continuous duty is allowed at temperatures of no less than 80°C.

8-9. (Cancelled)